Quad 2-input NOR gate Rev. 5 — 26 November 2015

Product data sheet

1. General description

The 74HC02; 74HCT02 is a quad 2-input NOR gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Input levels:
 - ◆ For 74HC02: CMOS level
 - ◆ For 74HCT02: TTL level
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

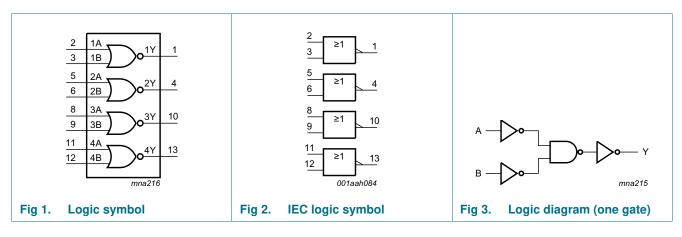
Table 1. Ordering information

Type number	Package				
	Temperature range	Name	Description	Version	
74HC02D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1	
74HCT02D			3.9 mm		
74HC02DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body	SOT337-1	
74HCT02DB	-		width 5.3 mm		
74HC02PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1	
74HCT02PW	-		body width 4.4 mm		
74HC02BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very	SOT762-1	
74HCT02BQ			thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm		



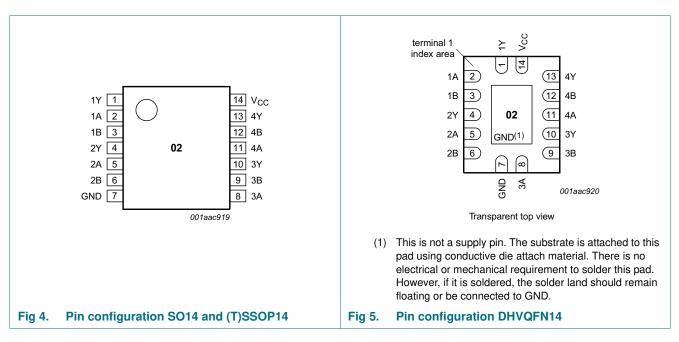
Quad 2-input NOR gate

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. **Pin description** Symbol Pin Description 1Y to 4Y 1, 4, 10, 13 data output 1A to 4A 2, 5, 8, 11 data input 1B to 4B 3, 6, 9, 12 data input GND 7 ground (0 V) 14 supply voltage V_{CC}

74HC_HCT02 Product data sheet

6. Functional description

Table 3.Function table^[1]

Input	Output	
nA	nB	nY
L	L	Н
X	Н	L
Н	X	L

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC} + 0.5$ V	<u>[1]</u>	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u>	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO14, (T)SSOP14 and DHVQFN14 packages	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC02			74HCT02		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

© NXP Semiconductors N.V. 2015. All rights reserved.

Quad 2-input NOR gate

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Мах	
74HC02	1	1								
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
o	output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current		-	-	±0.1	-	±1	-	±1	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 6.0 \ V \end{array}$	-	-	2.0	-	20	-	40	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

4 of 15

Quad 2-input NOR gate

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max		
74HCT0	2	1									
V _{IH}	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	2.0	1.6	-	2.0	-	2.0	-	V	
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	1.2	0.8	-	0.8	-	0.8	V	
011	HIGH-level	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$									
		output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V	
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$									
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 5.2 mA	-	0.15	0.26	-	0.33	-	0.4	V	
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1	-	±1	μA	
I _{CC}	supply current		-	-	2.0	-	20	-	40	μA	
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	150	540	-	675	-	735	μA	
CI	input capacitance		-	3.5	-	-	-	-	-	pF	

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see <u>Figure 7</u>.

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +125 ℃	Unit
		_		Min	Тур	Max	Max (85 °C)	Max (125 °C)	-
74HC02									
t _{pd} propagation delay	propagation delay	nA, nB to nY; see Figure 6	[1]						
	V _{CC} = 2.0 V		-	25	90	115	135	ns	
		$V_{CC} = 4.5 V$		-	9	18	23	27	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	7	-	-	-	ns
		$V_{CC} = 6.0 V$		-	7	15	20	23	ns
tt	transition time	see <u>Figure 6</u>	[2]						
		V _{CC} = 2.0 V		-	19	75	95	110	ns
		$V_{CC} = 4.5 V$		-	7	15	19	22	ns
		V _{CC} = 6.0 V		-	6	13	16	19	ns
C _{PD}	power dissipation capacitance	per package; $V_I = GND$ to V_{CC}	<u>[3]</u>	-	22	-	-	-	pF

Quad 2-input NOR gate

Symbol	Parameter	Conditions			25 °C		–40 °C to +125 °C		Unit
					Тур	Max	Max (85 °C)	Max (125 °C)	
74HCT02	2	1							
t _{pd} propagation	propagation delay	nA, nB to nY; see Figure 6	<u>[1]</u>						
		V _{CC} = 4.5 V		-	11	19	24	29	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	9	-	-	-	ns
tt	transition time	V _{CC} = 4.5 V; see Figure 6	[2]	-	7	15	19	22	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} – 1.5 V	<u>[3]</u>	-	24	-	-	-	pF

Table 7. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see <u>Figure 7</u>.

 $[1] \quad t_{pd} \mbox{ is the same as } t_{PHL} \mbox{ and } t_{PLH}.$

- $\label{eq:ttilde} [2] \quad t_t \text{ is the same as } t_{THL} \text{ and } t_{TLH}.$
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_{D}=C_{PD}\times V_{CC}{}^{2}\times f_{i}\times N+\Sigma~(C_{L}\times V_{CC}{}^{2}\times f_{o})$ where:

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma (C_L \times V_{CC}^2 \times f_o) = sum of outputs.$

11. Waveforms

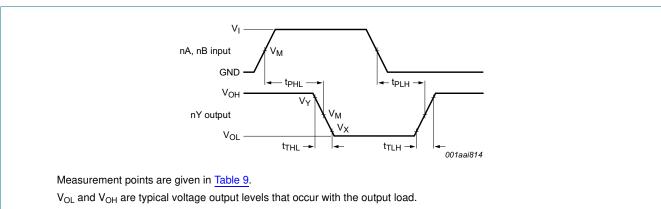


Fig 6. Input to output propagation delays

Table 8.Measurement points

Туре	Input	Output				
	V _M	V _M	V _X	V _Y		
74HC02	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}		
74HCT02	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}		

NXP Semiconductors

74HC02; 74HCT02

Quad 2-input NOR gate

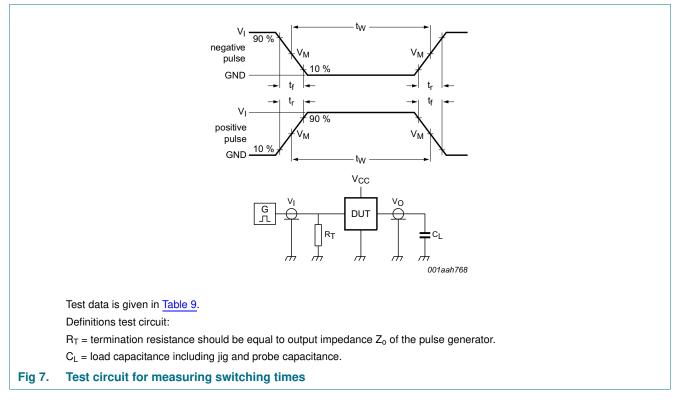


Table 9. Test data

Туре	Input I		Load	Test
	VI	t _r , t _f	CL	
74HC02	V _{CC}	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT02	3.0 V	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

Quad 2-input NOR gate

12. Package outline

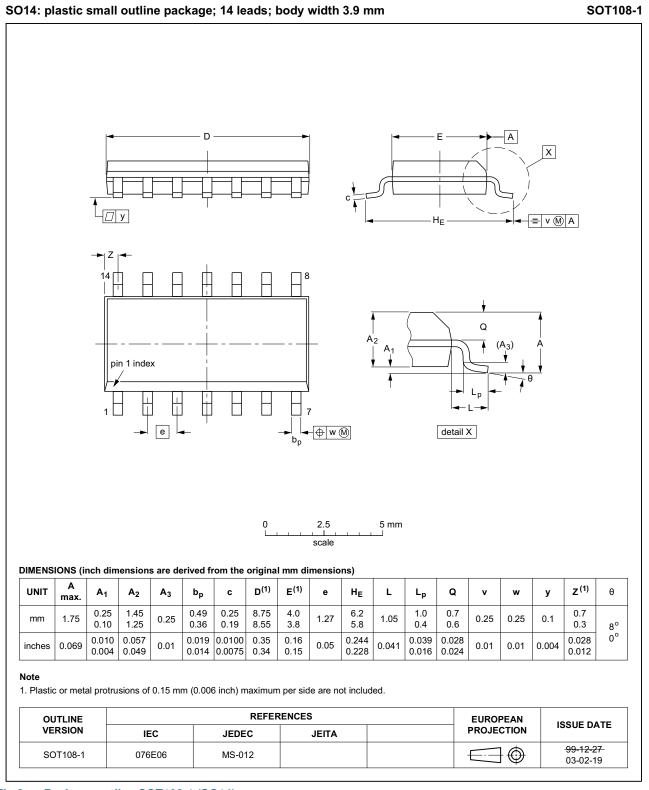


Fig 8. Package outline SOT108-1 (SO14)

74HC HCT02

Quad 2-input NOR gate

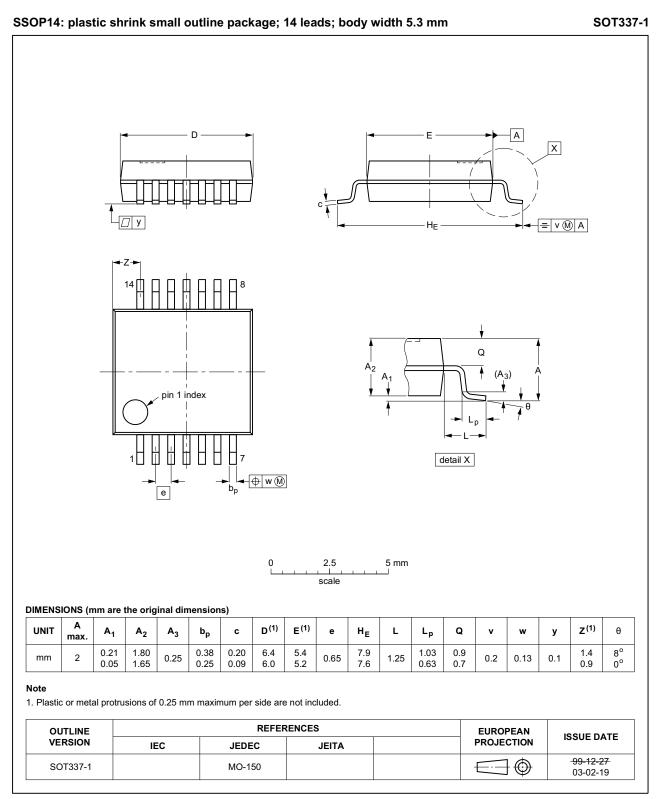


Fig 9. Package outline SOT337-1 (SSOP14)

74HC_HCT02

Quad 2-input NOR gate

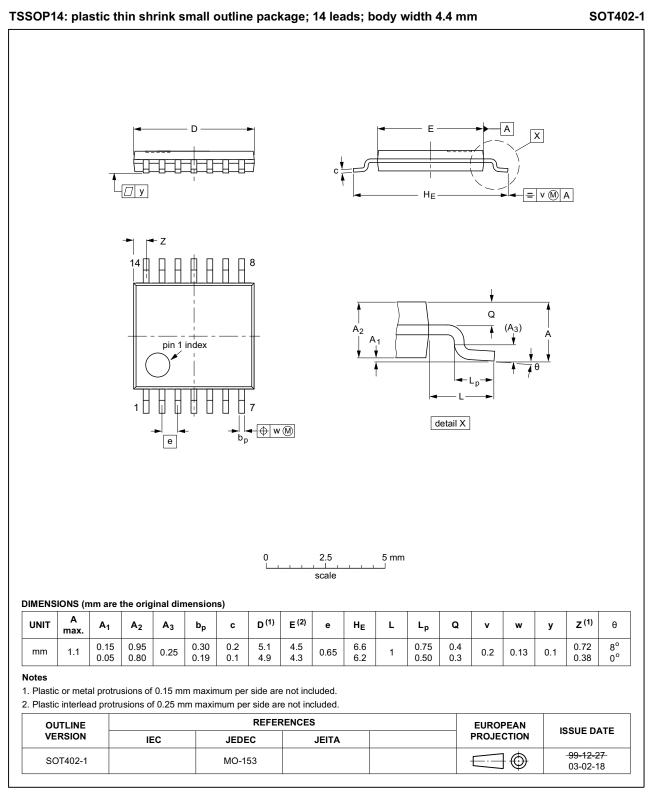
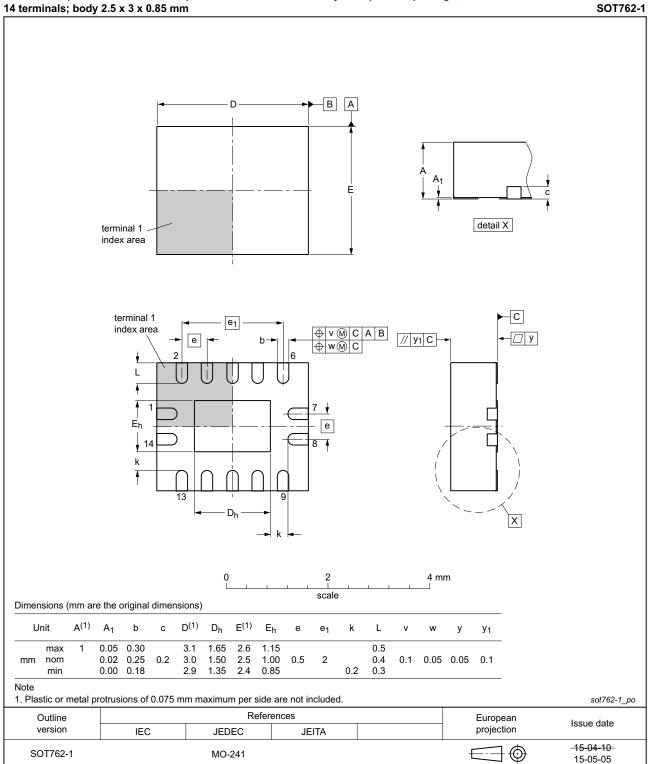


Fig 10. Package outline SOT402-1 (TSSOP14)

All information provided in this document is subject to legal disclaimers.

74HC_HCT02

Quad 2-input NOR gate



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;

Fig 11. Package outline SOT762-1 (DHVQFN14)

74HC_HCT02

13. Abbreviations

Table 10. Abbreviations							
Acronym	Description						
CMOS	Complementary Metal-Oxide Semiconductor						
DUT	Device Under Test						
ESD	ElectroStatic Discharge						
НВМ	Human Body Model						
MM	Machine Model						
TTL	Transistor-Transistor Logic						

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74HC_HCT02 v.5	20151126	Product data sheet	-	74HC_HCT02 v.4				
Modifications:	Type numbers 74HC	C02N and 74HCT02N (SC	T27-1) removed.					
74HC_HCT02 v.4	20120904	Product data sheet	-	74HC_HCT02 v.3				
Modifications:	 Conditions for V_{OH}, I_I and I_{CC} updated to the family specification (errata). 							
74HC_HCT02 v.3	20080918	Product data sheet	-	74HC_HCT02_CNV v.2				
Modifications:	 The format of this data of NXP Semiconduct 	ata sheet has been redesi tors.	gned to comply with the	e new identity guidelines				
	Legal texts have bee	en adapted to the new cor	mpany name where app	propriate.				
	 Added type numbers 74HC02BQ and 74HCT02BQ (DHVQFN14 package) 							
74HC_HCT02_CNV v.2	19970827	Product specification	-	-				

12 of 15

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP Semiconductors N.V. 2015. All rights reserved.

74HC HCT02

Quad 2-input NOR gate

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Functional diagram 2
5	Pinning information 2
5.1	Pinning 2
5.2	Pin description 2
6	Functional description 3
7	Limiting values 3
8	Recommended operating conditions 3
9	Static characteristics 4
10	Dynamic characteristics 5
11	Waveforms 6
12	Package outline 8
13	Abbreviations 12
14	Revision history 12
15	Legal information 13
15.1	Data sheet status 13
15.2	Definitions 13
15.3	Disclaimers
15.4	Trademarks 14
16	Contact information 14
17	Contents 15

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2015.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 26 November 2015 Document identifier: 74HC_HCT02